

L Number	Hits	Search Text	DB	Time stamp
15	4	6353265.URPN.	USPAT	2003/06/30 07:08
16	3	("6087722" "6118184" "6265760").PN.	USPAT	2003/06/30 07:09
129	4	6291881.URPN.	USPAT	2003/06/30 07:12
130	7	("5530292" "5545922" "5793108" "5917242" "5952725" "5959347" "6002178").PN.	USPAT	2003/06/30 07:13
249	47	("4410905" "4595945" "4780795" "4862245" "4937656" "4949161" "5086018" "5147815" "5229329" "5229639" "5233220" "5250840" "5256598" "5303120" "5327009" "5331200" "5360992" "5381036" "5384488" "5396701" "5434106" "5438478" "5508565" "5519576" "5521426" "5523617" "5528075" "5530292" "5532189" "5541446" "5563443" "5585667" "5585668" "5589420" "5592020" "5612259" "5637915" "5696665" "5726860" "5780925" "5789808" "5804870" "5804871" "5843809" "5903050" "5903443" "5907769").PN.	USPAT	2003/06/30 07:17
250	1	6144089.URPN.	USPAT	2003/06/30 07:18
595	53	5495398.URPN.	USPAT	2003/06/30 07:37
602	10	("3925801" "4809054" "4975763" "5014112" "5049527" "5151559" "5295044" "5296737" "5327325" "5331235").PN.	USPAT	2003/06/30 07:39
717	1195	(chip adj1 chip) and (leadframe (lead adj frame))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/06/30 07:56
718	440	((chip adj1 chip) and (leadframe (lead adj frame))) and memory	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/06/30 07:57
719	12874	(chip adj1 chip) ((second near1 (chip die)) near3 (attach\$3 stacked mounted mounting))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/06/30 07:56
720	1477	((chip adj1 chip) ((second near1 (chip die)) near3 (attach\$3 stacked mounted mounting))) and (leadframe (lead adj frame))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/06/30 07:57
721	542	((chip adj1 chip) ((second near1 (chip die)) near3 (attach\$3 stacked mounted mounting))) and (leadframe (lead adj frame)) and memory	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/06/30 07:57
722	142	((chip adj1 chip) ((second near1 (chip die)) near3 (attach\$3 stacked mounted mounting))) and (leadframe (lead adj frame)) and memory and (((die mounting) adj pad) (mounting adj area) (metal adj base))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/06/30 08:40
723	5	("5754567" "6100594" "6125061" "6157080" "6265783").PN.	USPAT	2003/06/30 08:01
724	12	6100594.URPN.	USPAT	2003/06/30 08:02
725	3	("6087722" "6118184" "6265760").PN.	USPAT	2003/06/30 08:07
726	4	("5012323" "5689135" "5804874" "5898212").PN.	USPAT	2003/06/30 08:08
727	93	5012323.URPN.	USPAT	2003/06/30 08:09
728	3	5646830.URPN.	USPAT	2003/06/30 08:12
729	9	("4472876" "4751482" "4801999" "5010390" "5012323" "5150194" "5347429" "5400218" "5422435").PN.	USPAT	2003/06/30 08:13
730	16	5150194.URPN.	USPAT	2003/06/30 08:18
731	10	("4541003" "5502289" "5614766" "5640044" "5801432" "5814881" "6025648" "RE36613" "6072243" "6077724").PN.	USPAT	2003/06/30 08:23
732	10	5814881.URPN.	USPAT	2003/06/30 08:24

733	9	("5502289" "5814881" "5952725" "6005778" "6087722" "6198136" "6208018" "6215182" "6316838" "2002/0017718"). PN.	USPAT	2003/06/30 08:26
734	16	("5012323" "5049979" "5128831" "5291061" "5323060" "5331235" "5365409" "5422435" "5434745" "5438224" "5455445" "5581498" "5608262" "5625235" "5644167" "5930599"). PN.	USPAT	2003/06/30 08:27
735	11	("5012323" "5296737" "5331235" "5347429" "5438224" "5463253" "5471369" "5479051" "5523608" "5545922" "5640044"). PN.	USPAT	2003/06/30 08:29
736	10	("5243208" "5386623" "5717245" "5783870" "5894166" "5923090" "5923091" "5946545" "5995379" "6057598"). PN.	USPAT	2003/06/30 08:32
737	5	6255736.URPN.	USPAT	2003/06/30 08:33
738	18	"6025640"	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/06/30 08:47
739	14	6025640.URPN.	USPAT	2003/06/30 08:48
740	2	("5592025" "5635755"). PN.	USPAT	2003/06/30 08:48

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15	4	6353265.URPN.	USPAT	2003/06/30 07:08
16	3	("6087722" "6118184" "6265760").PN.	USPAT	2003/06/30 07:09
129	4	6291881.URPN.	USPAT	2003/06/30 07:12
130	7	("5530292" "5545922" "5793108" "5917242" "5952725" "5959347" "6002178").PN.	USPAT	2003/06/30 07:13
249	47	("4410905" "4595945" "4780795" "4862245" "4937656" "4949161" "5086018" "5147815" "5229329" "5229639" "5233220" "5250840" "5256598" "5303120" "5327009" "5331200" "5360992" "5381036" "5384488" "5396701" "5434106" "5438478" "5508565" "5519576" "5521426" "5523617" "5528075" "5530292" "5532189" "5541446" "5563443" "5585667" "5585668" "5589420" "5592020" "5612259" "5637915" "5696665" "5726860" "5780925" "5789808" "5804870" "5804871" "5843809" "5903050" "5903443" "5907769").PN.	USPAT	2003/06/30 07:17
250	1	6144089.URPN.	USPAT	2003/06/30 07:18
595	53	5495398.URPN.	USPAT	2003/06/30 07:37
602	10	("3925801" "4009054" "4975763" "5014112" "5049527" "5151559" "5295044" "5296737" "5327325" "5331235").PN.	USPAT	2003/06/30 07:39
717	1195	(chip adj1 chip) and (leadframe (lead adj frame))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/06/30 07:56
718	440	((chip adj1 chip) and (leadframe (lead adj frame))) and memory	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/06/30 07:57
719	12874	(chip adj1 chip) ((second near1 (chip die)) near3 (attach\$3 stacked mounted mounting))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/06/30 08:51
720	1477	((chip adj1 chip) ((second near1 (chip die)) near3 (attach\$3 stacked mounted mounting))) and (leadframe (lead adj frame))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/06/30 08:59
721	542	((chip adj1 chip) ((second near1 (chip die)) near3 (attach\$3 stacked mounted mounting))) and (leadframe (lead adj frame)) and memory	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/06/30 07:57
722	142	(((chip adj1 chip) ((second near1 (chip die)) near3 (attach\$3 stacked mounted mounting))) and (leadframe (lead adj frame))) and memory and (((die mounting) adj pad) (mounting adj area) (metal adj base))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/06/30 09:01
723	5	("5754567" "6100594" "6125061" "6157080" "6265783").PN.	USPAT	2003/06/30 08:01
724	12	6100594.URPN.	USPAT	2003/06/30 08:02
725	3	("6087722" "6118184" "6265760").PN.	USPAT	2003/06/30 08:07
726	4	("5012323" "5689135" "5804874" "5898212").PN.	USPAT	2003/06/30 08:08
727	93	5012323.URPN.	USPAT	2003/06/30 08:09
728	3	5646830.URPN.	USPAT	2003/06/30 08:12
729	9	("4472876" "4751482" "4801999" "5010390" "5012323" "5150194" "5347429" "5400218" "5422435").PN.	USPAT	2003/06/30 08:13
730	16	5150194.URPN.	USPAT	2003/06/30 08:18
731	10	("4541003" "5502289" "5614766" "5640044" "5801432" "5814881" "6025648" "RE36613" "6072243" "6077724").PN.	USPAT	2003/06/30 08:23
732	10	5814881.URPN.	USPAT	2003/06/30 08:24

733	9	{"5502289" "5814881" "5952725" "6005778" "6087722" "6198136" "6208018" "6215182" "6316838" "2002/0017718").PN.	USPAT	2003/06/30 08:26
734	16	{"5012323" "5049979" "5128831" "5291061" "5323060" "5331235" "5365409" "5422435" "5434745" "5438224" "5455445" "5581498" "5608262" "5625235" "5644167" "5930599").PN.	USPAT	2003/06/30 08:27
735	11	{"5012323" "5296737" "5331235" "5347429" "5438224" "5463253" "5471369" "5479051" "5523608" "5545922" "5640044").PN.	USPAT	2003/06/30 08:29
736	10	{"5243208" "5386623" "5717245" "5783870" "5894166" "5923090" "5923091" "5946545" "5995379" "6057598").PN.	USPAT	2003/06/30 08:32
737	5	6255736.URPN.	USPAT	2003/06/30 08:33
738	18	"6025640"	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/06/30 08:47
739	14	6025640.URPN.	USPAT	2003/06/30 08:48
740	2	{"5592025" "5635755").PN.	USPAT	2003/06/30 08:48
741	400	((chip adj1 chip) ((second near1 (chip die)) near3 (attach\$3 stacked mounted mounting)) and (leadframe (lead adj frame)) and memory) not (((chip adj1 chip) ((second near1 (chip die)) near3 (attach\$3 stacked mounted mounting)) and (leadframe (lead adj frame)) and memory) and ((die mounting) adj pad) (mounting adj area) (metal adj base))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/06/30 08:50
742	95	((chip adj1 chip) ((second near1 (chip die)) near3 (attach\$3 stacked mounted mounting)) and (leadframe (lead adj frame)) and memory) not (((chip adj1 chip) ((second near1 (chip die)) near3 (attach\$3 stacked mounted mounting)) and (leadframe (lead adj frame)) and memory) and ((die mounting) adj pad) (mounting adj area) (metal adj base))) and ((second near (chip die)) near3 (attach\$3 stacked mounted mounting))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/06/30 08:51
743	2384	257/777 438/109	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/06/30 08:58
744	579	((leadframe (lead adj frame)) (lead adj finger)) near3 (grounding ground)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/06/30 09:01
745	56327	((leadframe (lead adj frame)) (lead adj finger))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/06/30 09:01
746	365	(grounding ground) near3 ((die mounting) adj pad) (mounting adj area) (metal adj base))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/06/30 09:04
747	5	(257/777 438/109) and ((grounding ground) near3 ((die mounting) adj pad) (mounting adj area) (metal adj base))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/06/30 09:03
748	40569	(257/777 438/109) ((die mounting) adj pad) (metal adj base))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/06/30 09:04

749	245	(257/777 438/109) and (((die mounting) adj pad) (metal adj base))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/06/30 09:04
750	170	(((leadframe (lead adj frame)) (lead adj finger))) and ((257/777 438/109) and (((die mounting) adj pad) (metal adj base)))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/06/30 09:05
751	136	(((leadframe (lead adj frame)) (lead adj finger))) and ((257/777 438/109) and (((die mounting) adj pad) (metal adj base))) not (((((chip adj1 chip) ((second near1 (chip die)) near3 (attach\$3 stacked mounted mounting))) and (leadframe (lead adj frame))) and memory) not (((((chip adj1 chip) ((second near1 (chip die)) near3 (attach\$3 stacked mounted mounting))) and (leadframe (lead adj frame))) and memory) and (((die mounting) adj pad) (mounting adj area) (metal adj base))) and ((second near (chip die)) near3 (attach\$3 stacked mounted mounting)) not (((((chip adj1 chip) ((second near1 (chip die)) near3 (attach\$3 stacked mounted mounting))) and (leadframe (lead adj frame))) and memory) and (((die mounting) adj pad) (mounting adj area) (metal adj base)))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/06/30 09:05
752	53	((((leadframe (lead adj frame)) (lead adj finger))) and ((257/777 438/109) and (((die mounting) adj pad) (metal adj base))) not (((((chip adj1 chip) ((second near1 (chip die)) near3 (attach\$3 stacked mounted mounting))) and (leadframe (lead adj frame))) and memory) not (((((chip adj1 chip) ((second near1 (chip die)) near3 (attach\$3 stacked mounted mounting))) and (leadframe (lead adj frame))) and memory) and (((die mounting) adj pad) (mounting adj area) (metal adj base))) and ((second near (chip die)) near3 (attach\$3 stacked mounted mounting)) not (((((chip adj1 chip) ((second near1 (chip die)) near3 (attach\$3 stacked mounted mounting))) and (leadframe (lead adj frame))) and memory) and (((die mounting) adj pad) (mounting adj area) (metal adj base)))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2003/06/30 09:05
753	4	("5479051" "6091144" "6118184" "6316838").PN.	USPAT	2003/06/30 09:08